LNJ876YK6AA

Round Type

φ3.2 mm

Absolute Maximum Ratings $T_a = 25^{\circ}C$

Parameter	Symbol	Rating	Unit	
Power dissipation	P _D	125	mW	
Forward current	I _F	50	mA	
Pulse forward current *	I _{FP}	150	mA	
Reverse voltage	V _R	4	V	
Operating ambient temperature	T _{opr}	-25 to +85	°C	
Storage temperature	T _{stg}	-30 to +100	°C	

Lighting Color

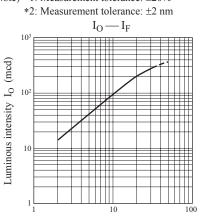
Soft Orange

Note) *: The condition of IFP is duty 10%, Pulse width 1 msec.

Electro-Optical Characteristics $T_a = 25^{\circ}C$

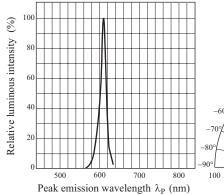
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Luminous intensity *1	Io	$I_F = 20 \text{ mA}$	40	200		mcd
Reverse current	I _R	$V_R = 4 V$			100	μΑ
Forward voltage	V _F	$I_F = 20 \text{ mA}$		2.0	2.5	V
Dominant emission wavelength *2	λ_d	$I_F = 20 \text{ mA}$		605		nm
Peak emission wavelength	λ_{P}	$I_F = 20 \text{ mA}$		610		nm
Spectral half band width	Δλ	$I_F = 20 \text{ mA}$		17		nm

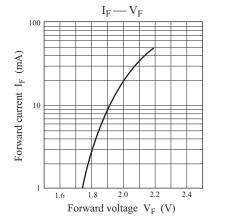
Note) *1: Measurement tolerance: ±20%

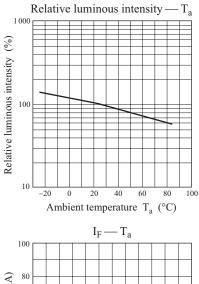


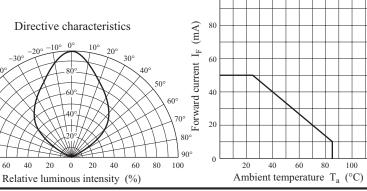
Forward current IF (mA)

Relative luminous intensity — λ_P





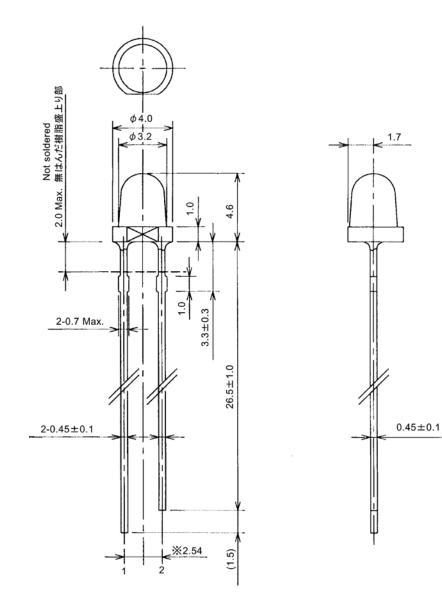




Publication date: July 2012

80 60 40 20 0 20 40 120

Package (Unit: mm)



• Pin name

1: Anode

2: Cathode

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